# Infrastructure of Cooperative and Incremental Verification Systems



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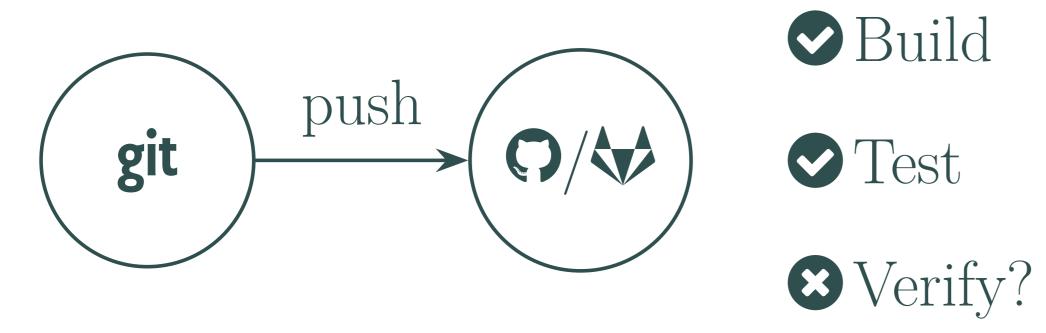






## Overview

Running verification tools in modern toolchains still poses challenges.

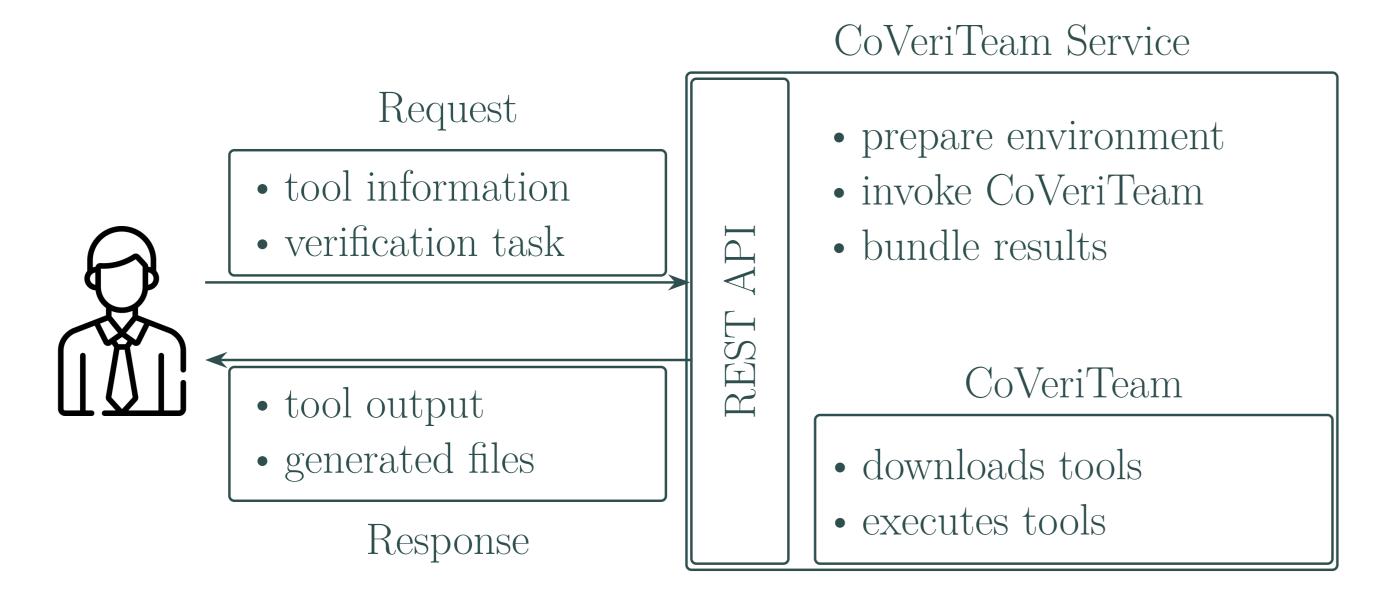


Stallenge: Special requirements on environment.

Challenge: Machine friendly interaction.

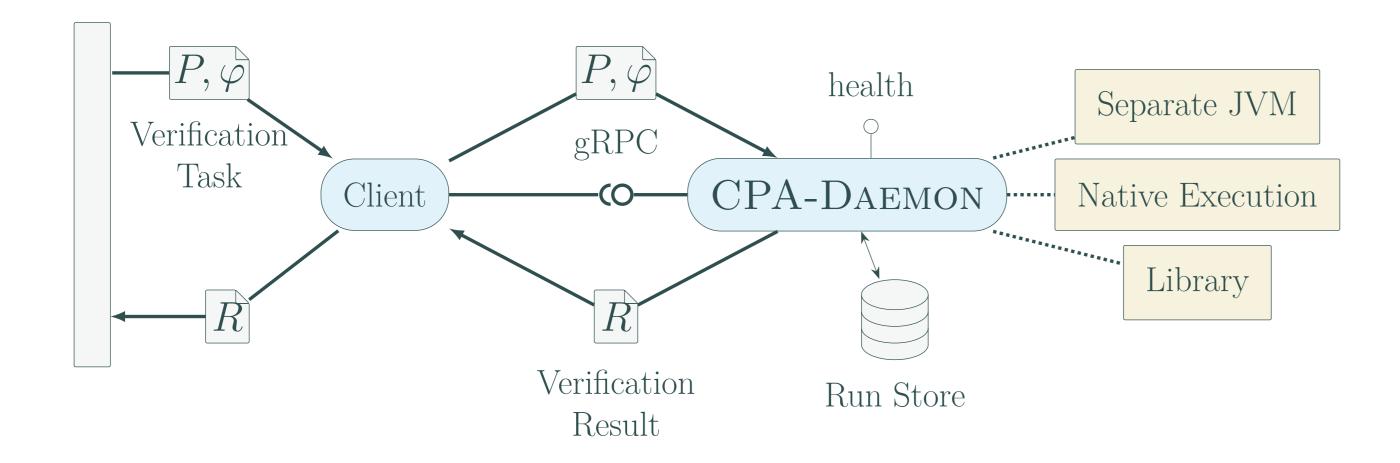
Challenge: Fast response time.

#### ■ Remote: CoVeriTeam Service

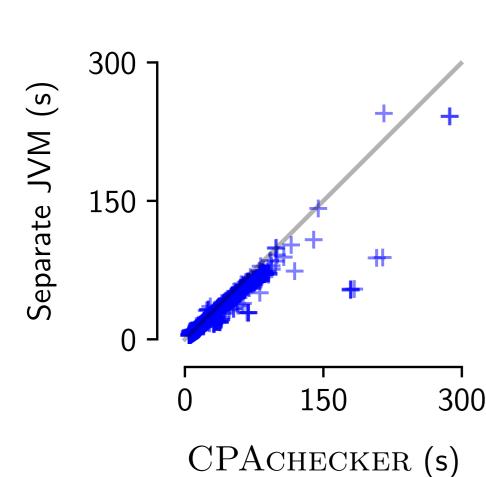


CoVeriTeam Service [3] is a web service building on CoVeriTeam [1]. It provides a decoupled stand machine friendly interface to formal methods tools.

## ■ Incremental: CPA-Daemon



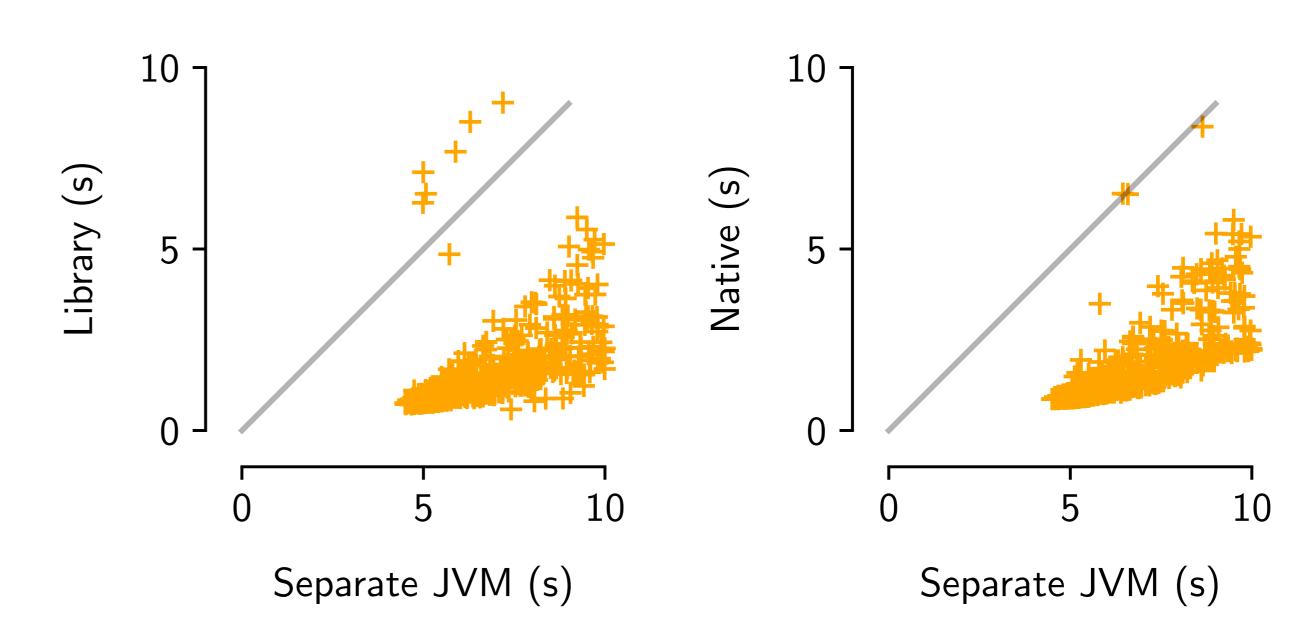
CPA-DAEMON is a daemon that provides a gRPC interface to CPACHECKER [2]. The framework enables stateful and incremental verification.



experiments Our compare CPACHECKER executed dalone and called through the gRPC wrapper (Separate JVM). There is no observable performance degradation resulting from the daemon.

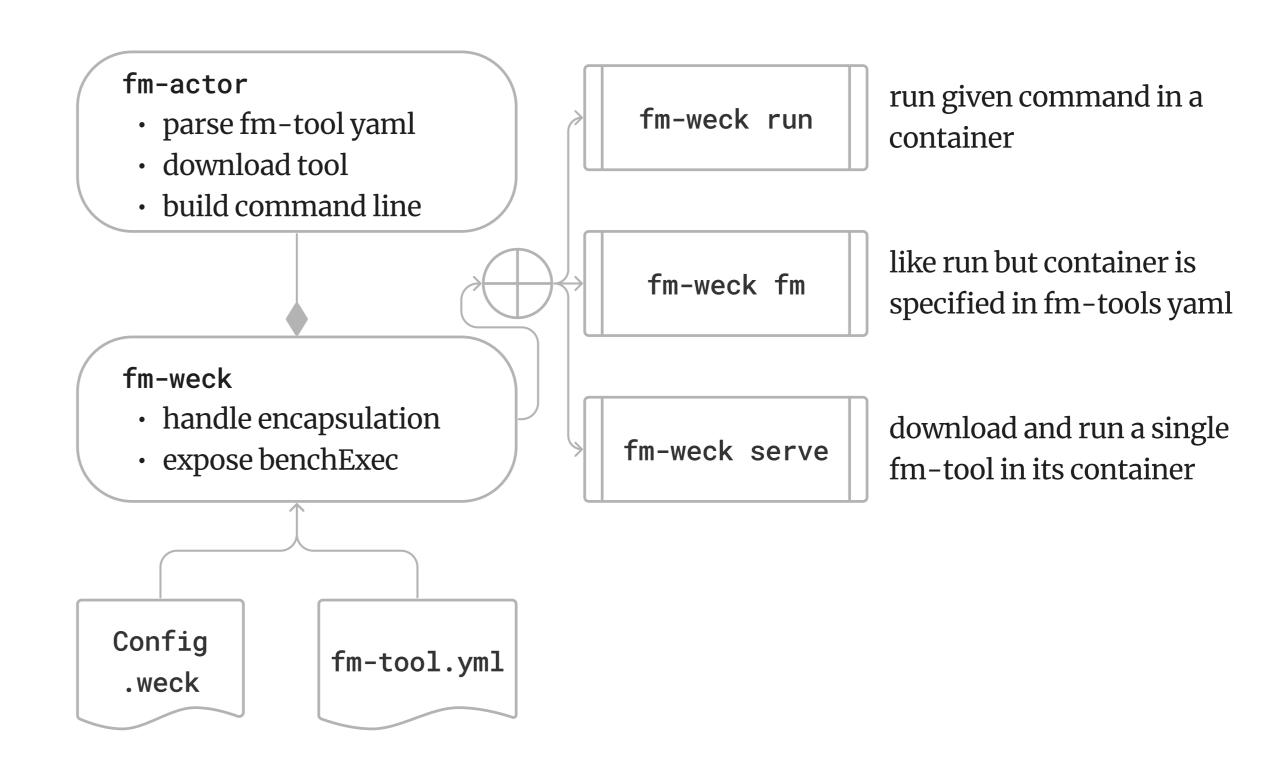
#### ■ CPA-Daemon: Backends

CPA-DAEMON ships several backends: Separate JVM Just wraps CPACHECKER Native Execution Runs a Graal native image Library Integrates CPACHECKER as a library



Both Library and Native Execution show a performance improvement ② over Separate JVM on short running verification tasks.

#### ■ fm-universe: Run and Conserve fm-tools



fm-weck, built on top of fm-actor , is a tool that runs formal methods tools in container environments \$\frac{\sigma}{\sigma}\$.

## **Explore!**







CoVeriTeam Service

CPA-DAEMON fm-weck

References

- [1] D. Beyer and S. Kanav. "CoVeriTeam: On-Demand Composition of Cooperative Verification Systems". In: *Proc. TACAS*. LNCS 13243. Springer, 2022, pp. 561–579.
- [2] D. Beyer and M. E. Keremoglu. "CPACHECKER: A Tool for Configurable Software Verification". In: *Proc. CAV.* LNCS 6806. Springer, 2011, pp. 184–190.
- [3] D. Beyer, S. Kanav, and H. Wachowitz. "CoVeriTeam Service: Verification as a Service". In: Comp. Proc. ICSE. IEEE, 2023.